

5010
12/05/2001

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
19010696	12/05/2001	257	758	2811	Guana Vu

**APPLICANTS: Yegnashankaran Visramohan; Padmanabhan Gobi;

**CONTINUING DATA VERIFIED:

**FOREIGN APPLICATIONS VERIFIED:

PG-PUB DO NOT PUBLISH ☒

RESCIND ☐

Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no
Verified and Acknowledged Examiner's initials

ATTORNEY DOCKET NO.
072219-0261614 (P05088)

TITLE: Multilevel metal interconnect and method of forming the interconnect with capacitive structures that adjust the capacitance of the interconnect

U.S. DEPT. OF COMMERCE, U.S. PATENT & TRADEMARK OFFICE

NOTES OF ALLOWANCE MAILED

ISSUE FEE

Amount Due: Date Paid:



TERMINAL

DISCLAIMER

Assistant Examiner

Primary Examiner

PREPARED FOR ISSUE

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